

General Description

The UD0018 is the highest performance trench N-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The UD0018 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|-----------------------|--------------------------------------------|------------|-------|
| V_{DS} | Drain-Source Voltage | 100 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D@T_C=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 45 | A |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 28 | A |
| $I_D@T_A=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 6.6 | A |
| $I_D@T_A=70^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 5.3 | A |
| I_{DM} | Pulsed Drain Current ² | 100 | A |
| EAS | Single Pulse Avalanche Energy ³ | 98 | mJ |
| I_{AS} | Avalanche Current | 41 | A |
| $P_D@T_C=25^\circ C$ | Total Power Dissipation ⁴ | 90 | W |
| $P_D@T_A=70^\circ C$ | Total Power Dissipation ⁴ | 2 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | °C |
| T_J | Operating Junction Temperature Range | -55 to 150 | °C |

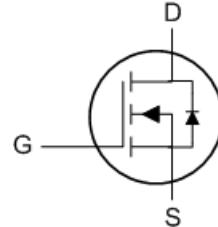
Product Summary

| BV _{DSS} | R _{DSON} | ID |
|-------------------|-------------------|-----|
| 100V | 22mΩ | 45A |

Applications

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- LED TV Back Light

TO252 Pin Configuration



Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--------------------------------------------------|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient ¹ | --- | 62 | °C/W |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case ¹ | --- | 1.4 | °C/W |

N-Ch 100V Fast Switching MOSFETs
Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|------------------------------------------------|--------------------------------------------------------------------------------|------|-------|-----------|----------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$ | 100 | --- | --- | V |
| $\Delta BV_{DSS}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_D=1\text{mA}$ | --- | 0.096 | --- | $\text{V}/^\circ\text{C}$ |
| $R_{DS(\text{ON})}$ | Static Drain-Source On-Resistance ² | $V_{GS}=10\text{V}$, $I_D=30\text{A}$ | --- | 18 | 22 | $\text{m}\Omega$ |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250\mu\text{A}$ | 2.5 | --- | 4.5 | V |
| $\Delta V_{GS(\text{th})}$ | $V_{GS(\text{th})}$ Temperature Coefficient | $V_{GS}=V_{DS}$, $I_D=250\mu\text{A}$ | --- | -5.5 | --- | $\text{mV}/^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=80\text{V}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | μA |
| | | $V_{DS}=80\text{V}$, $V_{GS}=0\text{V}$, $T_J=55^\circ\text{C}$ | --- | --- | 5 | |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$ | --- | --- | ± 100 | nA |
| g_{fs} | Forward Transconductance | $V_{DS}=5\text{V}$, $I_D=30\text{A}$ | --- | 27 | --- | S |
| R_g | Gate Resistance | $V_{DS}=0\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$ | --- | 1.9 | 3.8 | Ω |
| Q_g | Total Gate Charge (10V) | $V_{DS}=80\text{V}$, $V_{GS}=10\text{V}$, $I_D=30\text{A}$ | --- | 27.6 | 38.6 | nC |
| Q_{gs} | Gate-Source Charge | | --- | 11.4 | 16 | |
| Q_{gd} | Gate-Drain Charge | | --- | 7.9 | 11.1 | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}=50\text{V}$, $V_{GS}=10\text{V}$, $R_G=3.3\Omega$, $I_D=30\text{A}$ | --- | 15.6 | 31.2 | ns |
| T_r | Rise Time | | --- | 17.2 | 31 | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 16.8 | 33.6 | |
| T_f | Fall Time | | --- | 9.2 | 18.4 | |
| C_{iss} | Input Capacitance | $V_{DS}=15\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$ | --- | 1890 | 2645 | pF |
| C_{oss} | Output Capacitance | | --- | 268 | 375 | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 67 | 94 | |

Guaranteed Avalanche Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|--------------------------------------------|--------------------------------------------------------------|------|------|------|------|
| EAS | Single Pulse Avalanche Energy ⁵ | $V_{DD}=25\text{V}$, $L=0.1\text{mH}$, $I_{AS}=30\text{A}$ | 53 | --- | --- | mJ |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|------------------------------------------|-----------------------------------------------------------------------------|------|------|------|-------------|
| I_s | Continuous Source Current ^{1,6} | $V_G=V_D=0\text{V}$, Force Current | --- | --- | 45 | A |
| I_{SM} | Pulsed Source Current ^{2,6} | | --- | --- | 100 | A |
| V_{SD} | Diode Forward Voltage ² | $V_{GS}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_F=30\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$ | --- | 34 | --- | nS |
| Q_{rr} | Reverse Recovery Charge | | --- | 47 | --- | nC |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{DS}=25\text{V}$, $V_{GS}=10\text{V}$, $L=0.1\text{mH}$, $I_{AS}=41\text{A}$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

N-Ch 100V Fast Switching MOSFETs

Typical Characteristics

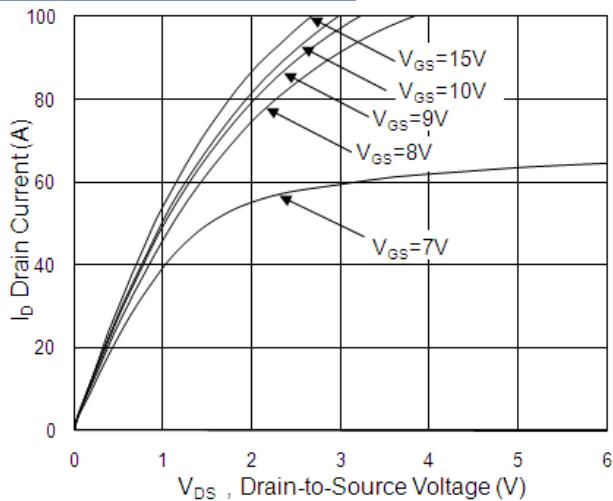


Fig.1 Typical Output Characteristics

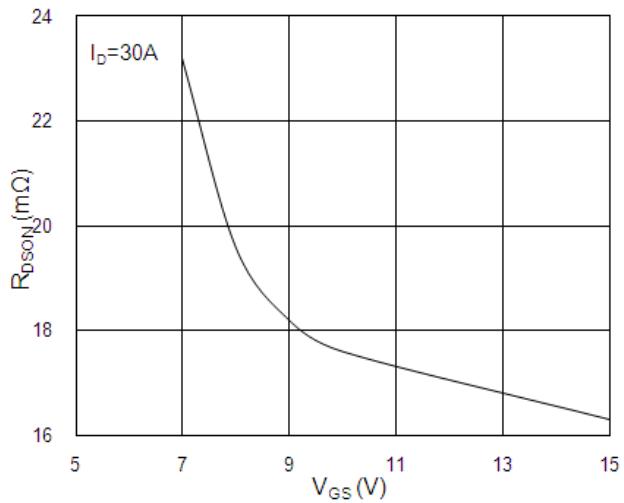


Fig.2 On-Resistance v.s Gate-Source

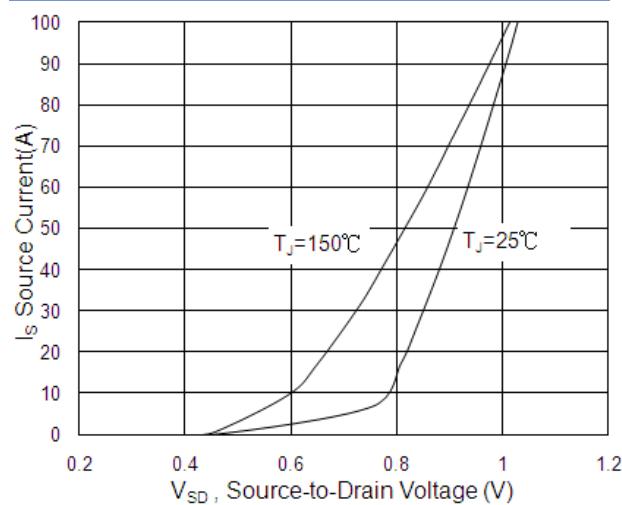


Fig.3 Forward Characteristics of Reverse

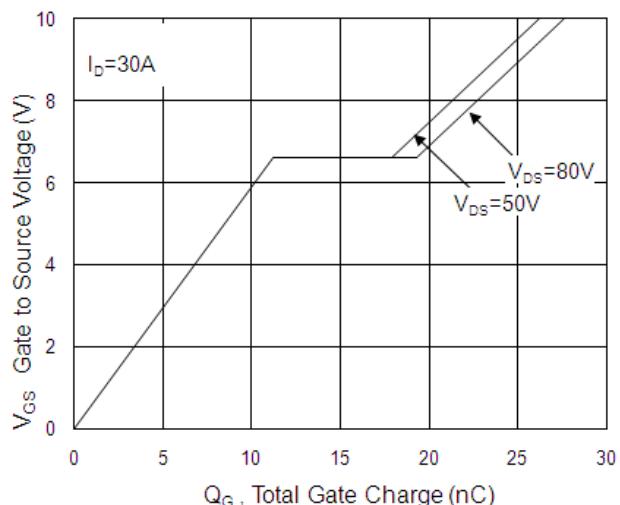


Fig.4 Gate-Charge Characteristics

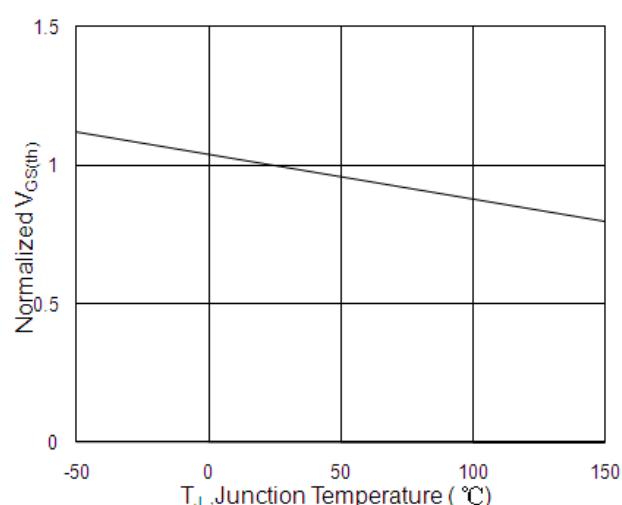


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

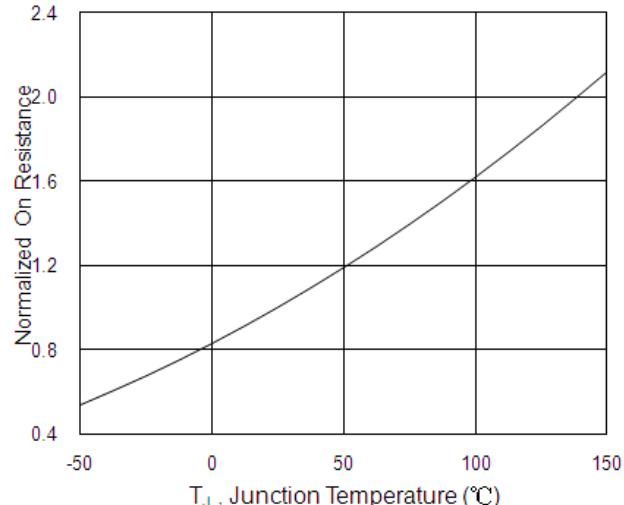


Fig.6 Normalized $R_{DS(on)}$ v.s T_J

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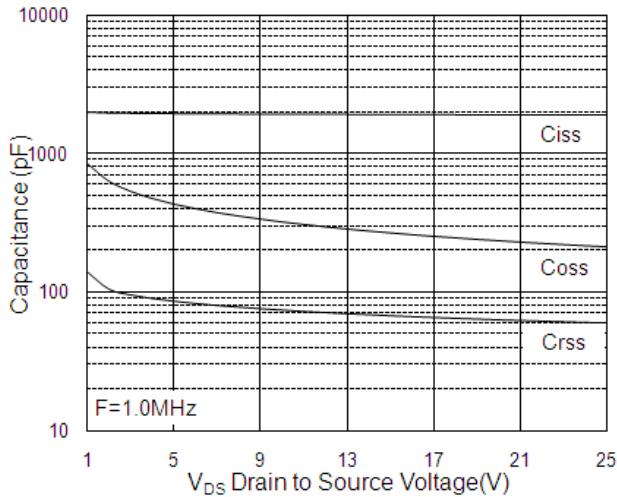


Fig.7 Capacitance

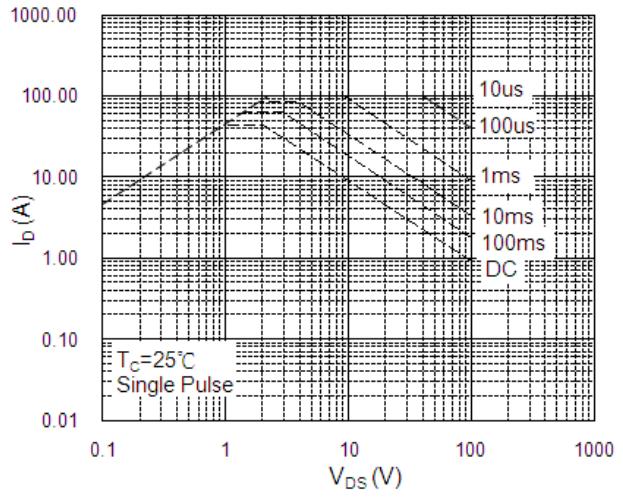


Fig.8 Safe Operating Area

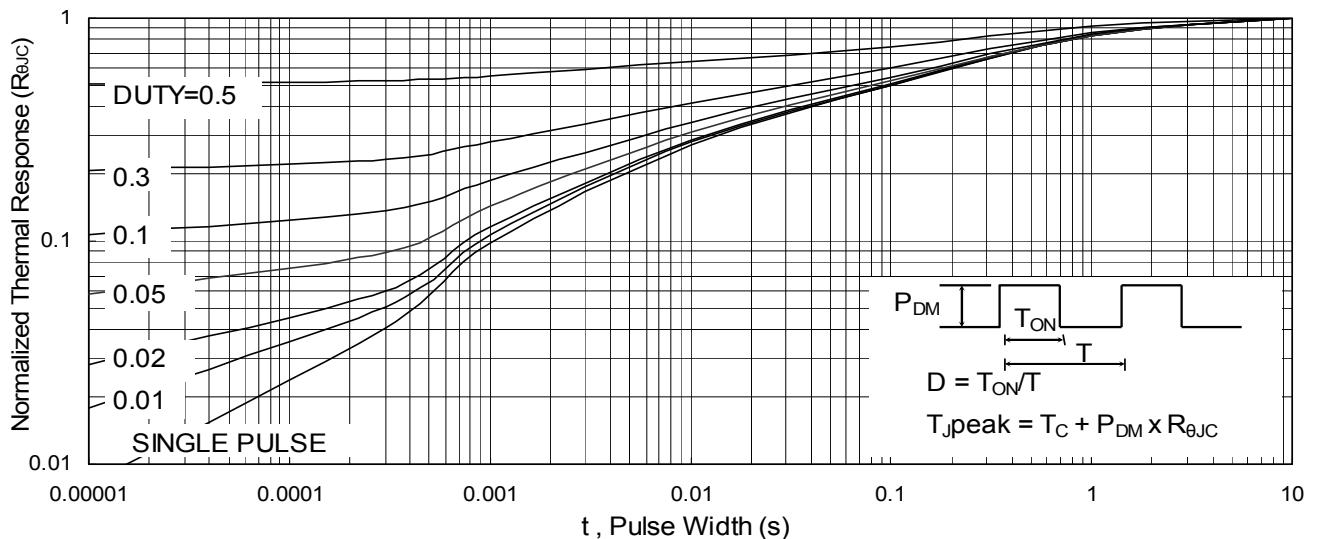


Fig.9 Normalized Maximum Transient Thermal Impedance

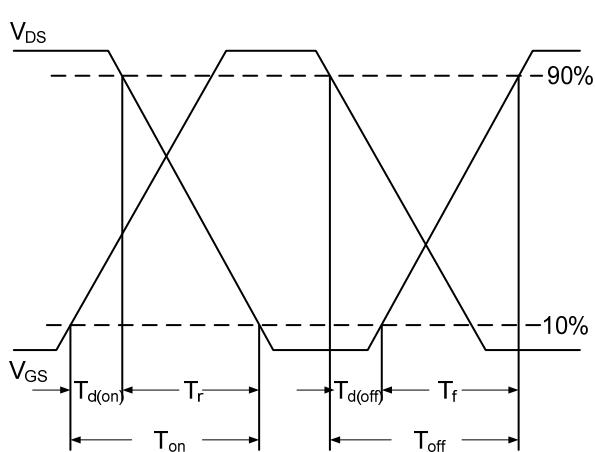


Fig.10 Switching Time Waveform

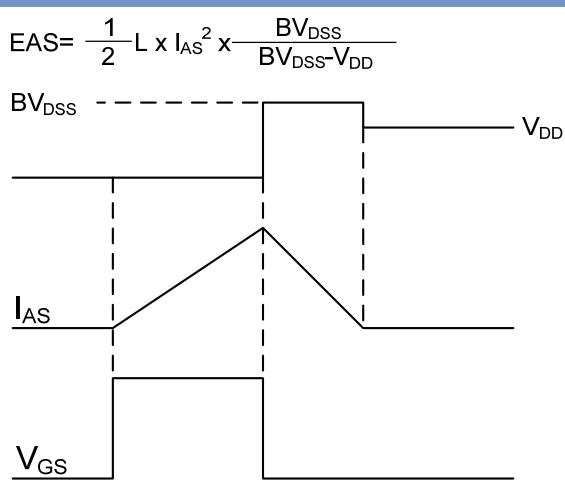


Fig.11 Unclamped Inductive Switching Waveform